

MULTI-INNO TECHNOLOGY CO., LTD.

www.multi-inno.com

LCD MODULE SPECIFICATION

Model: MI0500PT-7CP1

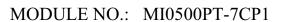
This module uses RoHS material

For Customer's Acceptance:

Customer	
Approved	
Comment	

This is a customized LCD module, with any changes related to mechanical, electrical or raw materials, Multi-Inno should get the formal approval from end customer first.

Revision	1.0
Engineering	
Date	2015-07-09
Our Reference	





REVISION RECORD

REV NO.	REV DATE	CONTENTS	REVISED PAGE NO.
1.0	2015-07-09	First Release	

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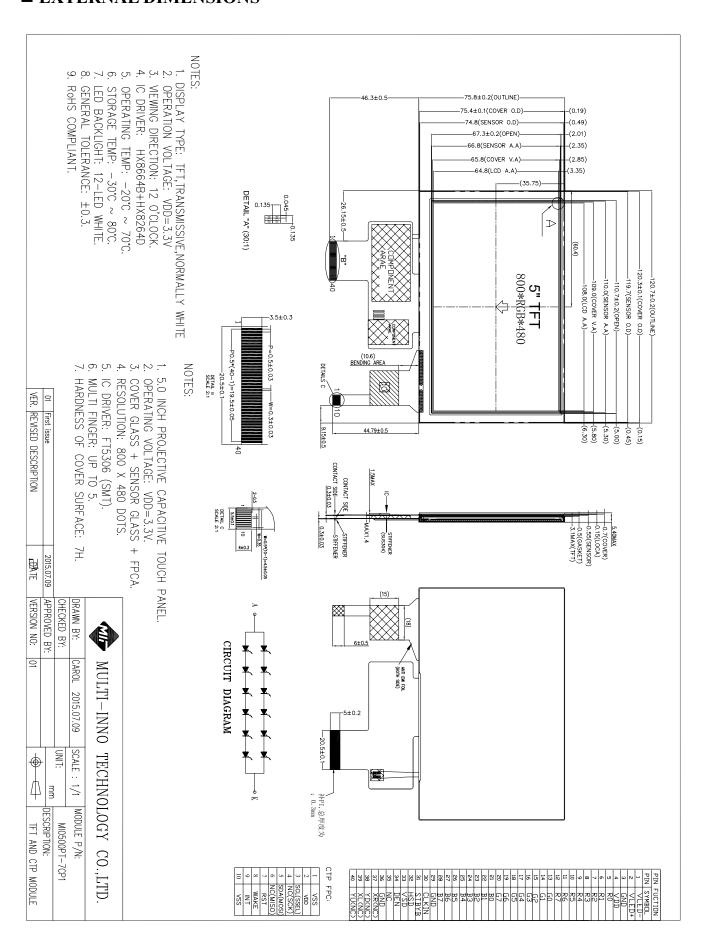
■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Normally white	/
Size	5.0	Inch
Viewing direction	12:00(without image inversion and least brightness	O' Clock
	change)	
Gray scale inversion direction	6:00 (contrast peak located at)	O' Clock
$LCM(W \times H \times D)$	120.7×75.8×5.4	mm^3
Active area (W×H)	108.0×64.8	mm^2
Pixel pitch (W×H)	0.135×0.135	mm^2
Number of dots	800 (RGB) × 480	/
Driver IC	HX8664B+HX8264D	/
Backlight type	12 LEDs	/
Interface type	24bit RGB	/
Color depth	16.7M	/
Pixel arrangement	RGB vertical stripe	/
Top polarizer surface treatment	Anti-glare	/
Panel power consumption	350	mW
Input voltage	3.3	V
With/Without TSP	With CTP	/
TP surface treatment	TBD	/
Weight	TBD	g

Note 1: RoHS compliant; Note 2: LCM weight tolerance: \pm 5% .



■ EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	VDD	-0.3	4.0	V
Input voltage for logic	VIN	-0.5	VDD+0.3	V
Supply current (one LED)	I LED	-	60	mA
Operating temperature	Тор	-20	70	°C
Storage temperature	Tst	-30	80	°C

■ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Supply voltage	VDD	3.0	3.3	3.6	V
Input leakage current	I_{LKG}	-	-	-	μΑ
Input voltage 'H' level	V _{IH}	0.8VDD	-	VDD	V
Input voltage 'L' level	VIL	-0.3	-	0.2VDD	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward voltage	Vf	17.4	18.3	19.6	V	Ta=25±2°C,
Forward current	If	30	40	50	mA	ĺ
Power consumption	WBL	522	732	980	mW	60%RH±5%
Operating life time	-	30000	50000	-	Hrs	

Note:

Operating life time means brightness goes down to 50% initial brightness;

The life time of LED will be reduced if LED is driven by high current, high ambient temperature and humidity conditions;

Typical operating life time is an estimated data.



■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min	Тур	Max	Unit	Remark	Note	
Response	time	Tr+Tf		-	20	-	ms	FIG 1.	4	
Contrast r	atio	Cr	θ=0°	-	500	-		FIG 2.	1	
Luminar uniform		δ WHITE	Ø=0° Ta=25°C	75	80	-	%	FIG 2.	3	
Surface Lum	inance	Lv		467	510	-	cd/m ²	FIG 2.	2	
			Ø = 90°	40	50	-	deg	FIG 3.		
Viovvina anal	Viewing angle range	::		Ø = 270°	60	70	-	deg	FIG 3.	6
viewing angi		θ	$\emptyset = 0$ °	60	70	-	deg	FIG 3.		
			Ø = 180°	60	70	-	deg	FIG 3.		
	Red	X		0.540	0.590	0.640				
	Reu	у		0.300	0.350	0.400				
	Green	X	θ=0°	0.298	0.348	0.398				
CIE (x, y)	Green	у	Ø=0°	0.520	0.570	0.620		FIG 2.	5	
chromaticity	Blue	X	Ta=25℃	0.095	0.145	0.195		110 2.		
_	Diuc	у	1 a-23 C	0.060	0.110	0.160				
	White	X		0.270	0.320	0.370				
	W IIIC	у		0.310	0.360	0.410				

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.:

Contrast Ratio = Average Surface Luminance with all white pixels (P₁,P₂, P₃,P₄, P₅)

Average Surface Luminance with all black pixels (P₁, P₂, P₃,P₄, P₅)

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels $(P_1, P_2, P_3, P_4, P_5)$

Note 3. The uniformity in surface luminance , δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

 $\delta \text{ WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}{\text{Maximum Surface Luminance with all white pixels } (P_1, P_2, P_3, P_4, P_5)}$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series

Note 5. CIE (x, y) chromaticity, The x,y value is determined by measuring luminance at each test position 1 through 5, and then make average value

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For Viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments. For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

Note 8. For TFT module, Gray scale reverse occurs in the direction of panel viewing angle.



FIG.1. The definition of Response Time

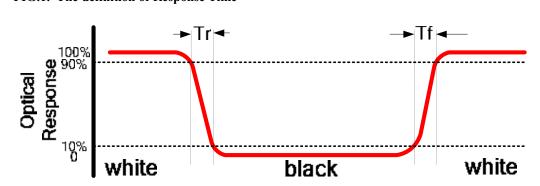


FIG.2. Measuring method for Contrast ratio, surface luminance, Luminance uniformity, CIE (x, y) chromaticity

A:5 mm

B:5 mm

H,V: Active Area

Light spot size \varnothing =5mm, 500mm distance from the

LCD surface to detector lens

measurement instrument is TOPCON's luminance

meter BM-5

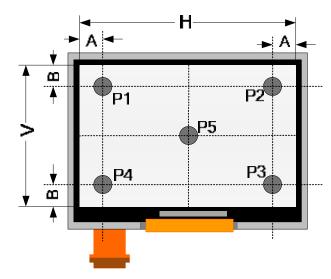
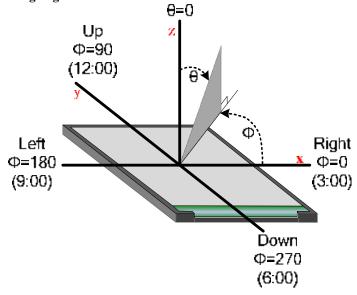


FIG.3. The definition of viewing angle





■ INTERFACE DESCRIPTION

Pin No	Symbol	Function				
1	VLED-	Backlight power ground				
2	VLED+	Backlight power supply				
3	GND	Power ground				
4	VDD	Power supply				
5-12	R0-R7	Red data				
13-20	G0-G7	Green data				
21-28	B0-B7	Blue data				
29	GND	Power ground				
30	CLKIN	In external interface mode, served as a dot clock signal.				
31	STBYB	standby mode control pin				
32	HSD	In external interface mode, served as a horizontal synchronized signal input				
33	VSD	In external interface mode, served as a vertical synchronize signal input				
34	DEN	In external interface mode, polarity of ENABLE signal is synchronized with valid graphic data input.				
35	NC	No connection				
36	GND	Power ground				
37	XR(NC)					
38	YD(NC)	Touch panel control pin				
39	XL(NC)	Touch panel control pin				
40	YU(NC)					

NOTE:For digital RGB input data format, both SYNC mode and DE+SYNC mode are supported. If ENB signal is fixed low. SYNC mode is used. Otherwise, DEN+SYNC is used



■ BLOCK DIAGRAM

Driver IC: HX8664B + HX8261D or Compatible Timing Controller with Memory /RESET G480 R[0:7] Y1 G[0:7] B[0:7] Source Driver CLKIN **Connection with Host** VSD HSD Y800 DEN Gate Driver VDD VSS G1 **LEDA** BL Circuit (2*6LED) LEDK SCL/SDA **CTP** INT/RESET



■ APPLICATION CIRCUIT NOTES

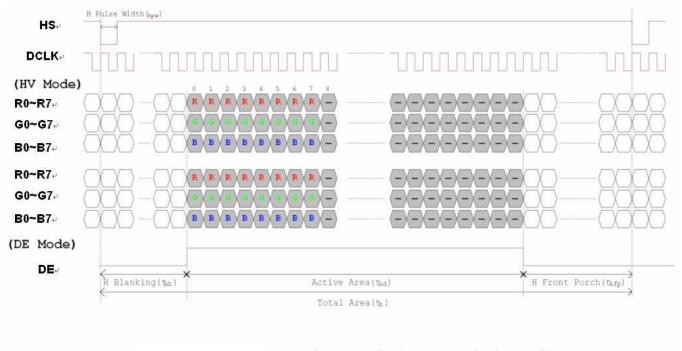
1. AC Characteristics

1.1 AC electrical characteristics

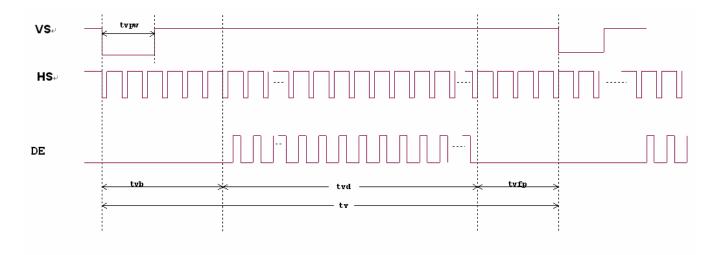
T.	Cryssla a 1		Values		Unit	Remark
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hold time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
DV _{DD} Power On Slew rate	Tpor	-	-	20	ms	From 0 to 90% DV _{DD}
RESET pulse width	TRst	10	-	-	ms	
DCLK cycle time	Tcoh	20	-	-	ns	
DCLK pulse duty	Tewh	40	50	60	%	



1.2 Data input format



Horizontal input timing diagram.



Vertical input timing diagram.



1.2.1 Timing

I. La cons	Symbol	Values			Unit	Remark
Item	Symbol	Min.	Тур.	Max.	Ollit	Kelliaik
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk		30	50	MHz	
One Horizontal Line	th	889	928	1143	DCLK	
HS pulse width	thpw	1	48-	255	DCLK	
HS Blanking	thb		88		DCLK	
HS Front Porch	thfp	1	40	255	DCLK	

14	Crysola ol		Values	II 14	Dl-	
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	513	525	767	TH	
VS pulse width	tvpw	3	3	255	TH	
VS Blanking	tvb		32		TH	
VS Front Porch	tvfp	1	13	255	TH	



■ CTP SPECIFICATIONS

1. GENERAL SPECIFICATIONS

Item	Specification	
Туре	Transparent type projected capacitive touch panel	
Input mode	Human's finger	
Finger	Up to 5	
Resolution	800 x 480	dots
Outline Dimension	120.3(W) x 75.4(H) x 1.9(D)	mm
Sensor Active Area	110.0(W)(typ.) x 66.8(H)(typ.)	mm
Hardness	7H	Pencil hardness
Driver IC	FT5306	/

2. ABSOLUTE MAXIMUM RATINGS

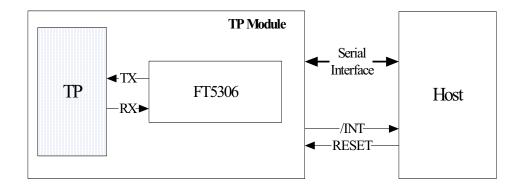
Symbol	Description	Min	Тур.	Max	Unit	Notes
VCC	Supply voltage for logic	-	3.3	-	V	
IDD	Supply current for logic	-	TBD	-	mA	

3. PIN CONNECTIONS

No.	Type	Name	Description
1	Р	VSS	Ground
2	Р	VCC	Power supply
3	I/O	SCL(SSEL)	I ² C clock input.
4	•	NC(SCK)	No connection.
5	I/O	SDA(MOSI)	l ² C data signal.
6	ı	NC(MISO)	No connection
7	I/O	RST	Reset.active low.
8	-	WAKE	No connection
9	I/O	INT	Interrupt signal to host from CTP.
10	Р	VSS	Ground

Note: More CTP driver information pls refer to driver's spec (FT5306) or consult with our technical team.

4. BLOCK DIAGRAM





5. CTP TIMING

1. I2C TIMING

The I2C is always configured in the Slave mode. The data transfer format is shown in Figure 2-4.

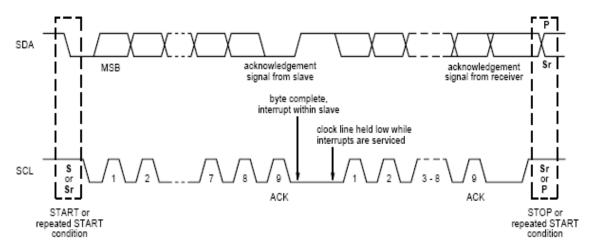


Figure 2-4 I2C Serial Data Transfer Format

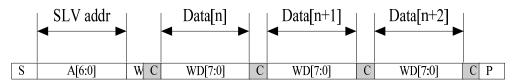


Figure 2-5 I2C master write, slave read

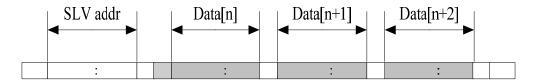


Figure 2-6 I2C master read, slave write

Table 2-1 lists the meanings of the mnemonics used in the above figures.

Table 2-1 Mnemonics Description

Mnemonics	Description	
S	I2C Start or I2C Restart	
A[6:0]	Slave address A[6:4]: 3'b011 A[3:0]: data bits are identical to those of I2CCON[7:4] register.	
W	1'b0: Write	
R	1'b1: Read	
С	ACK	
P	STOP: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)	



I2C Interface Timing Characteristics is shown in Table 2-2.

Table 2-2 I2C Timing Characteristics

Parameter	Unit	Min	Max
SCL frequency	KHz	0	400
Bus free time between a STOP and START condition	us	4.7	\
Hold time (repeated) START condition	us	4.0	\
Data setup time	ns	250	\
Setup time for a repeated START condition	us	4.7	\
Setup Time for STOP condition	us	4.0	\



■ RELIABILITY TEST

No.	Test Item	Test Condition
1	High Temperature Storage	80 ± 2 °C/240hours
2	Low Temperature Storage	-30 ± 2 °C/240hours
3	High Temperature Operating	70 ± 2 °C/120hours
4	Low Temperature Operating	-20±2°C/120hours
5	Temperature Cycle	$-30\pm2^{\circ}\text{C} \sim 25 \sim 80\pm2^{\circ}\text{C} \times 10 \text{ cycles}$ (30min.) (5min.) (30min.)
6	Damp Proof Test	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%\text{RH/240}\text{hours}$
7	Vibration Test	Frequency: 10Hz~55Hz Amplitude of vibration: 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.
8	Packing drop test	According to ASTM-D-5327
9	Electrical static discharge	Air: ± 8 KV 150 pF/ $330\Omega 5$ times
		Contact: ±4KV 150pF/330Ω5 time



■ INSPECTION CRITERION

	OUTGOING QUALITY STANDARD	PAGE 1 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA		

This specification is made to be used as the standard acceptance/rejection criteria for Color mobile phone LCM.

1 Sample plan

1.1 Lot size: Quantity per shipment lot per model

1.2 Sampling type: Normal inspection, Single sampling

1.3 Inspection level: II

1.4 Sampling table: MIL-STD-105D1.5 Acceptable quality level (AQL)

Majot defect: AQL=0.65 Minor defect: AQL=1.00

2. Inspection condition

2.1 Ambient conditions:

a. Temperature: Room temperature $25\pm5^{\circ}$ C

b. Humidity: (60± 10) %RH

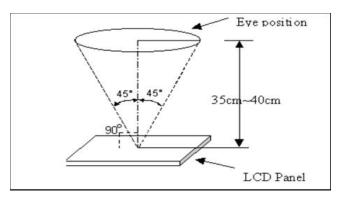
c. Illumination: Single fluoresænt lamp non-directive (300 to 700 Lux)

2.2 Viewing distance:

The distance between the LCD and the inspector's eyes shall be at least $35\pm$ 5cm.

2.3 Viewing Angle

U/D: 45° /45° , L/R: 45° /45°





MIT	OUTGOING QUALITY STANDARD	PAGE 2	OF	5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA				

3. Inspection standards

Defects are classified as majot defects and minor defects according to the degree of defectiveness defined herein.

3.1 Major defect

Item No	Items to be inspected	Inspection Standard
3.1.1	All functional defects	 No display Display abnormally Short circuit line defect
3.1.2	Missing	Missing function component
3.1.3	Crack	Glass crack

3.2 Minor defect

Item No	Items to be inspected	Inspection standard			
	Spot Defect Including	For dark/white spot is def $\varphi = (\mathbf{x} + \mathbf{y}) / 2$ $\longrightarrow \mathbf{X} \qquad \qquad$	ined		
	Black spot	Size φ(mm)	Acceptable Quantity		
3.2.1	White spot Pinhole Foreign particle Polarizer dirt	Pinhole φ≤0.20 Foreign particle	Pinhole	φ≤0.20	Ignore
			0.20 < φ≤ 0.50	3	
			0.50<φ	Not allowed	



MIT	OUTGOIN	G QUALITY STANDARD	PAGE 3 OF 5
TITLE:FUN	CTIONAL TEST & II	NSPECTION CRITERIA	
	Line Defect Including	Define:	Width
3.2.2	Black line White line	Width(mm) Length(mm)	Acceptable Quantity

	Line Defect Including	Length	Width
3.2.2	3.2.2 Black line White line Scratch	Width(mm) Length(mm)	Acceptable Quantity
	Scratch	W≤0.02	Ignore
		0.02 < W≤0.05 L≤5.0	4
		0.05 < W	Not allowed
		Size φ(mm)	Acceptable Quantity
		φ≤0.25	Ignore
	Polarizer Dent/Bubble	0.25<φ≤0.5	3
3.2.3		0.5< φ	0
		Bright and Black dot def	ine:
3.2.4	Electrical Dot Defect	Inspection pattern: Full and blue screens	white, Full black, Red, green
		Item	Acceptable Quantity
		Black dot defect	5
		Bright dot defect	2
		Total Dot	5



MI		IG QUALITY STANDARD	PAGE 4 OF 5
ΓITLE:FUN	CTIONAL TEST & I	NSPECTION CRITERIA	
	Touch panel defect	1.Corner Fragment: Size(mm)	Acceptable Quantity
		X≤3mm	Treespanie Quality
3.2.5		Y≤3mm Z≤T	Ignore
			T: Glass thickness
		Z-1	X: Length
			Y: Width
			Z: thickness
		2. Side Fragment:	X Z
		Size(mm)	Acceptable Quantity
		X≤5.0mm Y ≤3mm Z≤T	Ignore
			T: Glass thickness
			X: Length
		Z=1	Y: Width
			Z: thickness
3.2.6	Touch panel spot	Size φ(mm)	Acceptable Quantity
		φ≤0.25	Ignore
		0.25 <φ≤0.5	4
		0.5 < φ	0





OUTGOING QUALITY STANDARD

PAGE 5 OF 5

TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA

3.2.7	Touch panel White line Scratch	Width(mm) Length(mm)	Acceptable Quantity
		W≤0.03	Ignore
		0.03 < W≤0.05 L≤5.0	4
		0.05 < W or L>5	Not allowed
3.2.8	Touch panel Newton ring	Compare with limit sample	

Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

- 2. The distance between black dot defects or black and bright dot defects should be more than 5mm apart. The distance between two bright dot defects should be more than 15mm apart
- 3. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.
- 4. Mura is checker by 6% ND filter.
- 5. Foreign particle on the surface of the LCM should be ignore.

■ PRECAUTIONS FOR USING LCD MODULES

1 Handing Precautions

- 1.1 The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- 1.2 If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- 1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on it. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming in to contact with room temperature air.
- 1.5 If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- 1.6 Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contact with oil and fats.

- 1.7 Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 1.8 Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 1.9 Do not attempt to disassemble or process the LCD module.
- 1.10 NC terminal should be open. Do not connect anything.
- 1.11 If the logic circuit power is off, do not apply the input signals.
- 1.12 Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Before removing LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded. Make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
 - To reduce the amount of static electricity generated, do not conduct assembling



and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dry. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- 1.13 Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist the LCM.



2 Handling precaution for LCM

- 2.1 LCM is easy to be damaged. Please note below and be careful for handling.
- 2.2 Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

2.3 Incorrect handling:



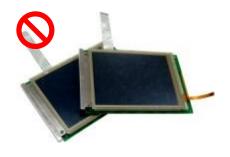
Please don't touch IC directly.



Please don't hold the surface of panel.



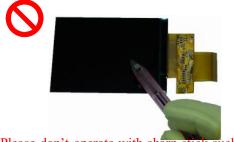
Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



3 Storage Precautions

- 3.1 When storing the LCD modules, the following precaution are necessary.
 - 3.1.1 Store them in a sealed polyethylene bag. If properly sealed, there is no need for the desiccant.
 - 3.1.2 Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.
 - 3.1.3 The polarizer surface should not come in contact with any other objects (We advise you to store them in the anti-static electricity container in which they were shipped).

3.2 Others 其它

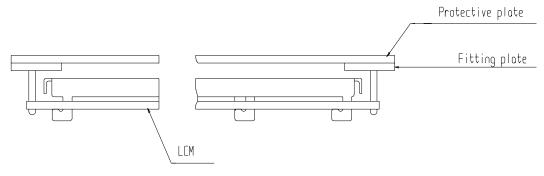
- 3.2.1 Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 3.2.2 If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3.2.3 To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - 3.2.3.1 Exposed area of the printed circuit board.
 - 3.2.3.2 -Terminal electrode sections.

4 USING LCD MODULES

4.1 Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

4.1.1 Cover the surface with a transparent protective plate to protect the polarizer and LC cell.

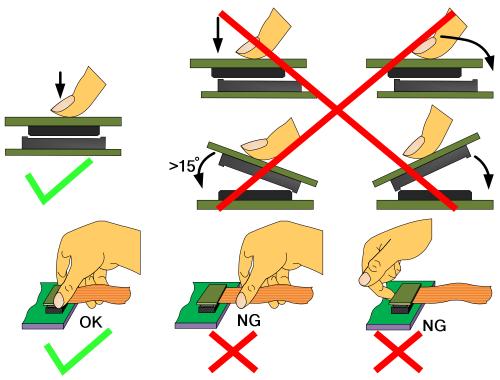


4.1.2 When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.



4.2 Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





4.3 Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No RoHS Product	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
		_	Press: 0.8~1.2Mpa
RoHS Product	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
	Time : 3-5S.	Speed: 15-17 mm/s.	Time : 3-6S.
			Press: 0.8~1.2Mpa

- 4.3.1 If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation (This does not apply in the case of a non-halogen type of flux). It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.
- 4.3.2 When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 4.3.3 When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

4.4 Precautions for Operation

- 4.4.1 Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.
- 4.4.2 It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- 4.4.3 Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operating temperature.
- 4.4.4 If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 4.4.5 A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.
- 4.4.6 Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.
- 4.4.7 Please keep the temperature within the specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

4.5 Safety

- 4.5.1 It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- 4.5.2 If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

4. 6 Limited Warranty

Unless agreed between Multi-Inno and the customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Inno limited to repair and/or replace on the terms set forth above. Multi-Inno will not be responsible for any subsequent or consequential events.

4.7 Return LCM under warranty

- 4.7.1 No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :
 - 4.7.1.1 Broken LCD glass.
 - 4.7.1.2 PCB eyelet is damaged or modified.
 - 4.7.1.3 -PCB conductors damaged.
 - 4.7.1.4 Circuit modified in any way, including addition of components.
 - 4.7.1.5 PCB tampered with by grinding, engraving or painting varnish.
 - 4.7.1.6 Soldering to or modifying the bezel in any manner.
- 4.7.2 Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PACKING SPECIFICATION

Please consult our technical department for detail information.

■ PRIOR CONSULT MATTER

- For Multi-Inno standard products, we keep the right to change material, process ... for improving the product property without prior notice to our customer.
- 2 For OEM products, if any changes are needed which may affect the product property, we will consult with our customer in advance.
- 3 If you have special requirement about reliability condition, please let us know before you start the test on our samples.